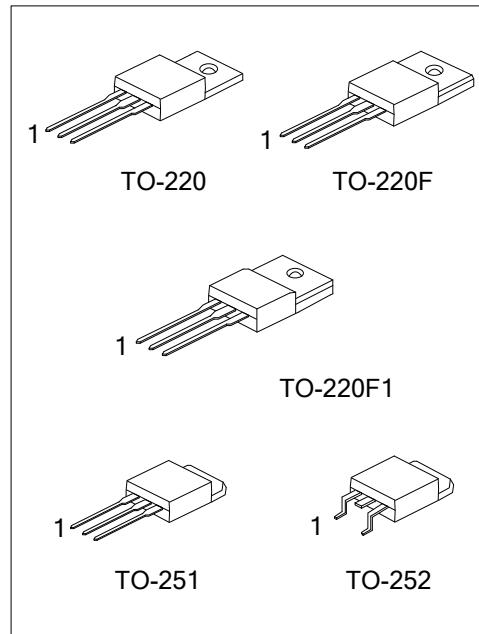
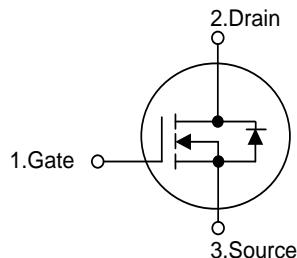


**9N50-TC****Power MOSFET****9A, 500V N-CHANNEL  
POWER MOSFET****■ DESCRIPTION**

The UTC **9N50-TC** is a high voltage power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

**■ FEATURES**

- \*  $R_{DS(ON)} \leq 1.0 \Omega$  @  $V_{GS}=10V$ ,  $I_D=4.5A$
- \* Fast switching capability
- \* Avalanche energy tested
- \* Improved dv/dt capability, high ruggedness

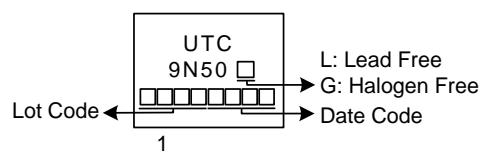
**■ SYMBOL****■ ORDERING INFORMATION**

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
9N50L-TA3-T	9N50G-TA3-T	TO-220	G	D	S	Tube
9N50L-TF1-T	9N50G-TF1-T	TO-220F1	G	D	S	Tube
9N50L-TF3-T	9N50G-TF3-T	TO-220F	G	D	S	Tube
9N50L-TM3-T	9N50G-TM3-T	TO-251	G	D	S	Tube
9N50L-TN3-R	9N50G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

 	(1) T: Tube, R: Tape Reel (2) TA3: TO-220, TF1: TO-220F1, TF3: TO-220F TM3: TO-251, TN3: TO-252 (3) G: Halogen Free and Lead Free, L: Lead Free
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## ■ MARKING



■ **ABSOLUTE MAXIMUM RATINGS** ( $T_C = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	$V_{DSS}$	500	V
Gate-Source Voltage	$V_{GSS}$	$\pm 30$	V
Continuous Drain Current	$I_D$	9	A
Pulsed Drain Current (Note 2)	$I_{DM}$	18	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	302 mJ
Peak Diode Recovery $dv/dt$ (Note 4)	$dv/dt$	6.46 V/ns	
Power Dissipation	TO-220	140	W
	TO-220F/TO-220F1	35	W
	TO-251/TO-252	60	W
Junction Temperature	$T_J$	+150	$^\circ\text{C}$
Storage Temperature	$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3.  $L = 10\text{mH}$ ,  $I_{AS} = 7.77\text{A}$ ,  $V_{DD} = 50\text{V}$ ,  $R_G = 25 \Omega$ , Starting  $T_J = 25^\circ\text{C}$

4.  $I_{SD} \leq 9.0\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$

■ **THERMAL DATA**

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-220F	$\theta_{JA}$	62.5 $^\circ\text{C/W}$
	TO-220F1		110 $^\circ\text{C/W}$
	TO-251/TO-252		
Junction to Case	TO-220	$\theta_{JC}$	0.9 $^\circ\text{C/W}$
	TO-220F/TO-220F1		3.57 $^\circ\text{C/W}$
	TO-251/TO-252		2.08 (Note) $^\circ\text{C/W}$

Note: Device mounted on FR-4 substrate  $P_c$  board, 2oz copper, with 1inch square copper plate.

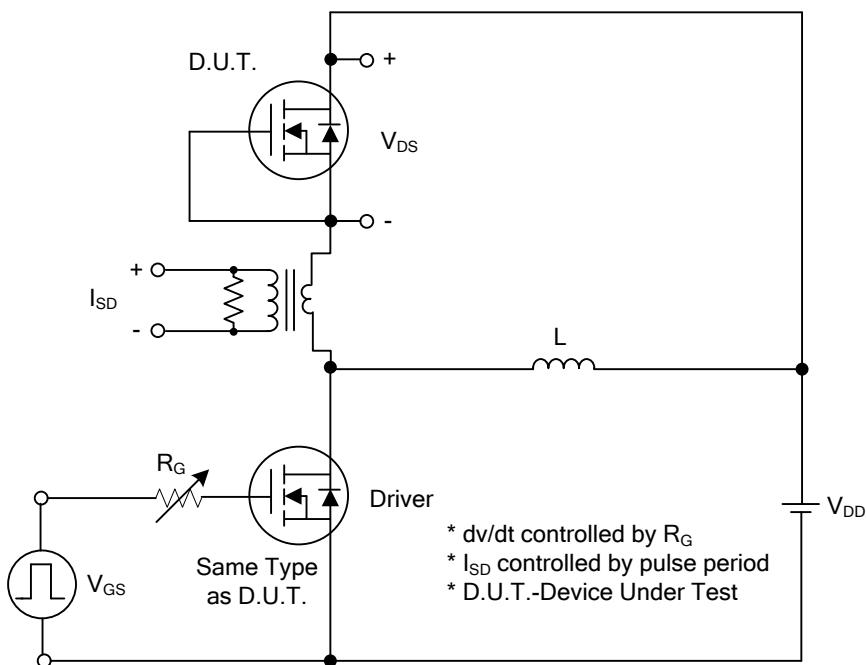
■ **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = 250\mu\text{A}$	500			V
Drain-Source Leakage Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 500\text{V}, V_{\text{GS}} = 0\text{V}$		10		$\mu\text{A}$
Gate- Source Leakage Current	Forward	$V_{\text{GS}} = 30\text{V}, V_{\text{DS}} = 0\text{V}$		100		nA
	Reverse	$V_{\text{GS}} = -30\text{V}, V_{\text{DS}} = 0\text{V}$		-100		nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{\text{GS(TH)}}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 250\mu\text{A}$	2.0		4.0	V
Static Drain-Source On-State Resistance	$R_{\text{DS(ON)}}$	$V_{\text{GS}} = 10\text{V}, I_{\text{D}} = 4.5\text{A}$			1.0	$\Omega$
<b>DYNAMIC CHARACTERISTICS</b>						
Input Capacitance	$C_{\text{ISS}}$	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1.0 \text{ MHz}$		898		pF
Output Capacitance	$C_{\text{OSS}}$			110		pF
Reverse Transfer Capacitance	$C_{\text{RSS}}$			5.2		pF
<b>SWITCHING CHARACTERISTICS</b>						
Total Gate Charge (Note 1)	$Q_G$	$V_{\text{DS}}=400\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=9.0\text{A}, I_{\text{D}}=1\text{mA}$ (Note 1, 2)		21		nC
Gate-Source Charge	$Q_{\text{GS}}$			6.2		nC
Gate-Drain Charge	$Q_{\text{GD}}$			4.8		nC
Turn-On Delay Time (Note 1)	$t_{\text{D(ON)}}$	$V_{\text{DD}}=100\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}} = 9.0\text{A}, R_{\text{G}}=25\Omega$ (Note 1, 2)		15		ns
Turn-On Rise Time	$t_R$			19		ns
Turn-Off Delay Time	$t_{\text{D(OFF)}}$			58		ns
Turn-Off Fall Time	$t_F$			25		ns
<b>DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS</b>						
Maximum Continuous Drain-Source Diode Forward Current	$I_S$				9	A
Maximum Pulsed Drain-Source Diode Forward Current	$I_{\text{SM}}$				18	A
Drain-Source Diode Forward Voltage	$V_{\text{SD}}$	$I_S=9.0\text{A}, V_{\text{GS}}=0\text{V}$			1.4	V
Body Diode Reverse Recovery Time	$t_{\text{rr}}$	$I_S=9.0\text{A}, V_{\text{GS}}=0\text{V} \text{ di/dt}=100\text{A}/\mu\text{s}$		276		ns
Body Diode Reverse Recovery Charge	$Q_{\text{rr}}$			2.9		$\mu\text{C}$

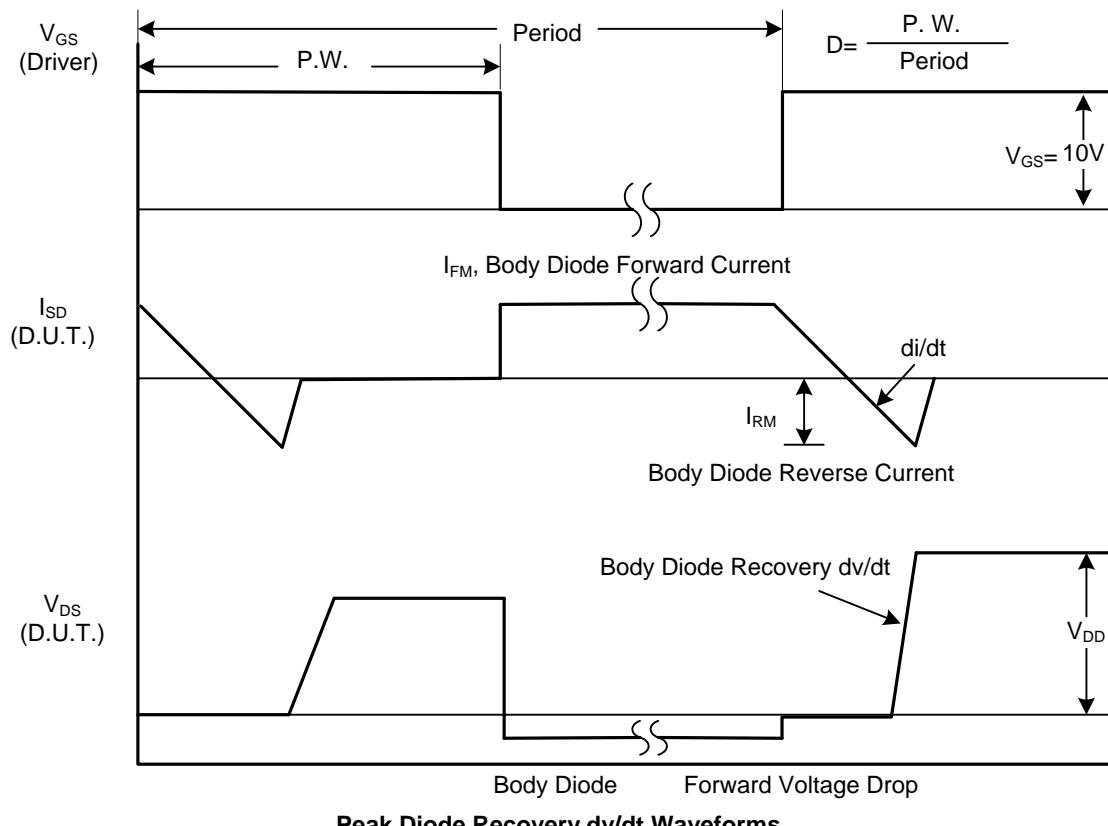
Notes: 1. Pulse Test: Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$ .

2. Essentially independent of operating temperature.

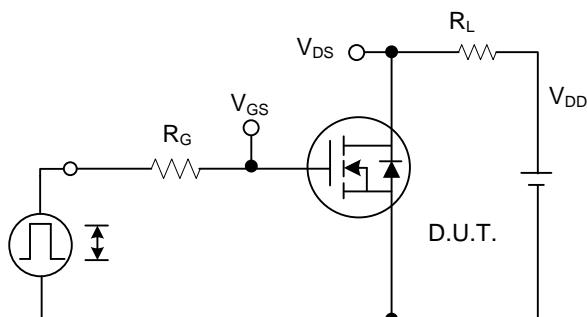
## ■ TEST CIRCUITS AND WAVEFORMS



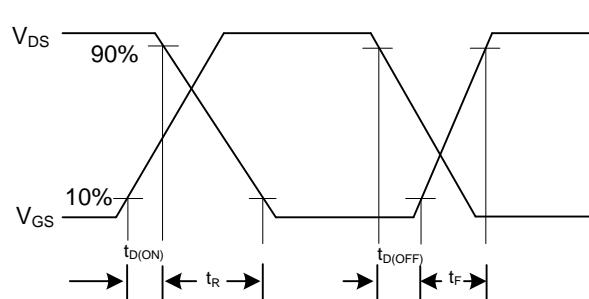
Peak Diode Recovery dv/dt Test Circuit



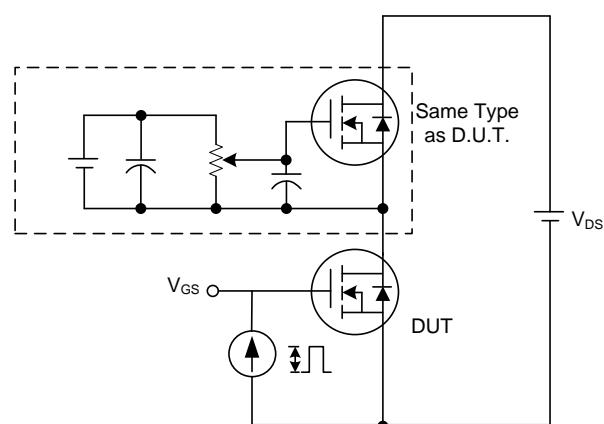
## ■ TEST CIRCUITS AND WAVEFORMS



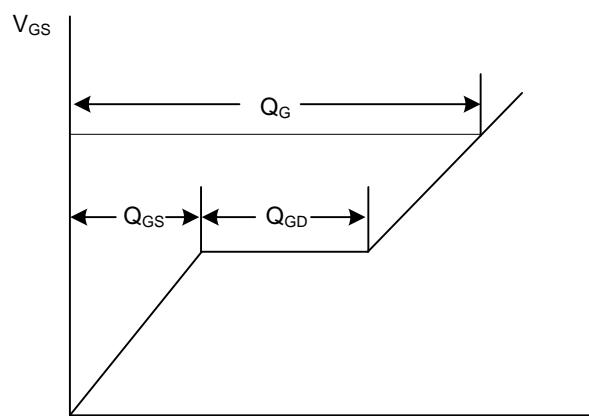
Switching Test Circuit



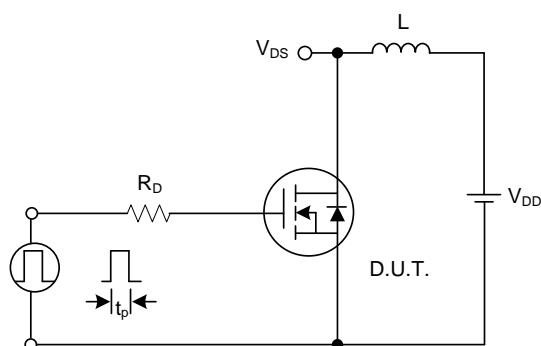
Switching Waveforms



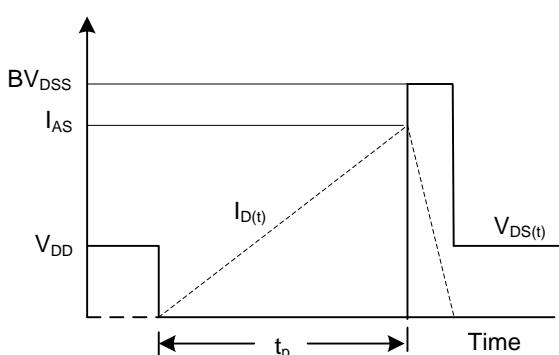
Gate Charge Test Circuit



Gate Charge Waveform

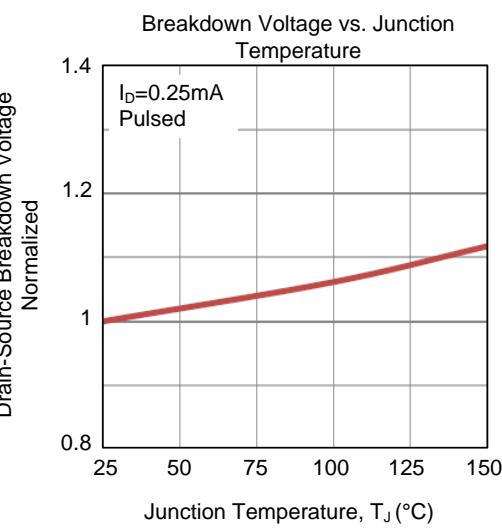
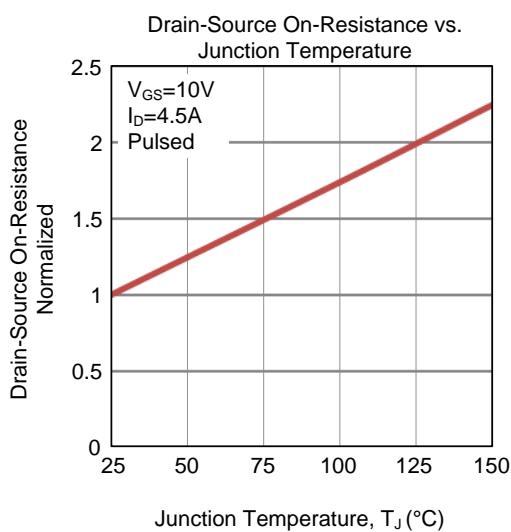
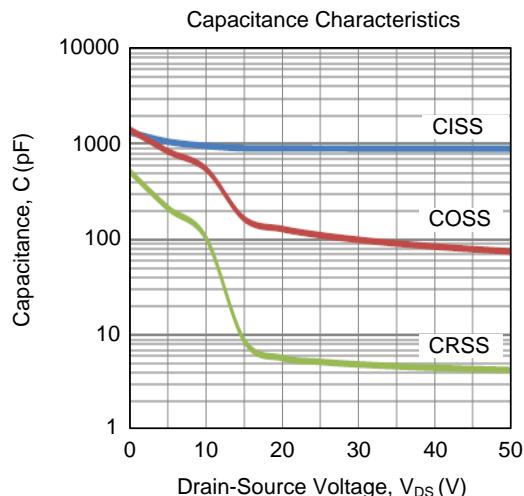
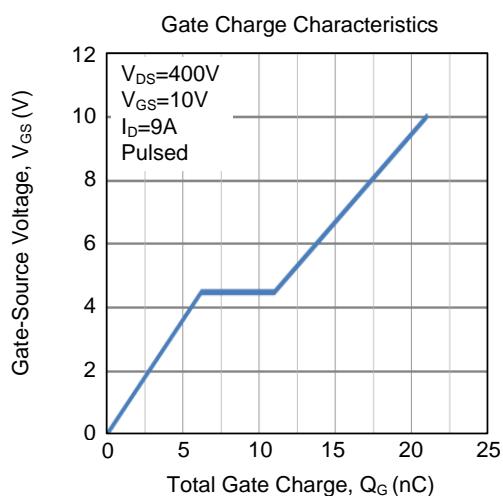
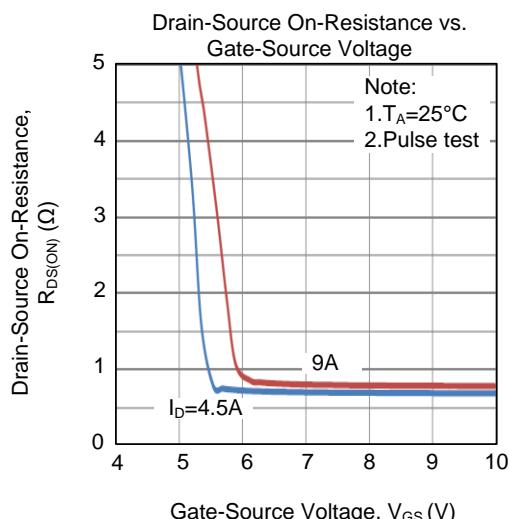
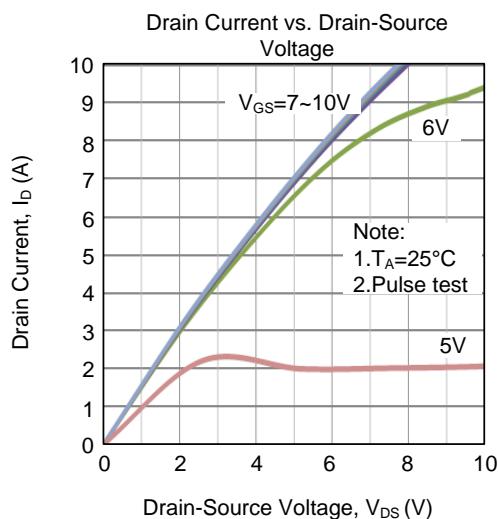


Unclamped Inductive Switching Test Circuit

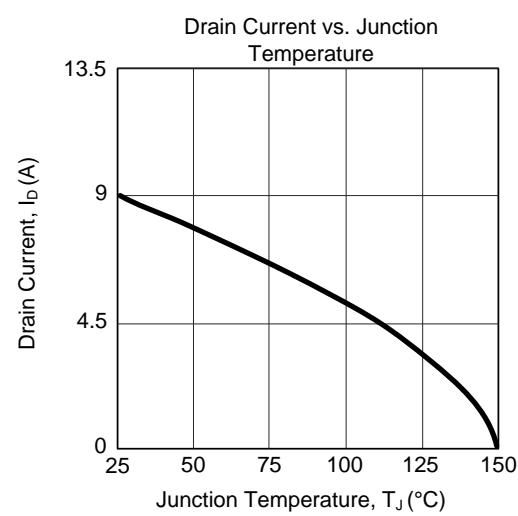
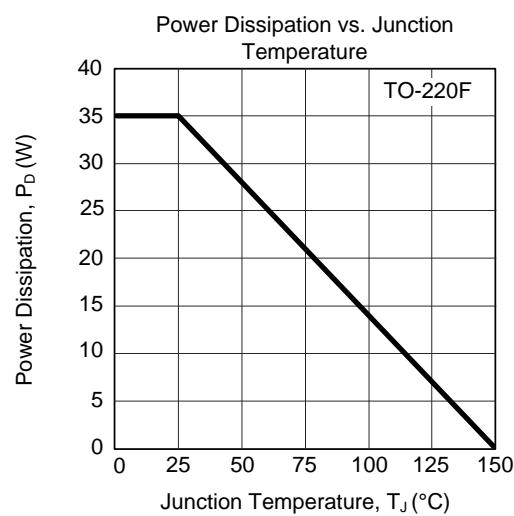
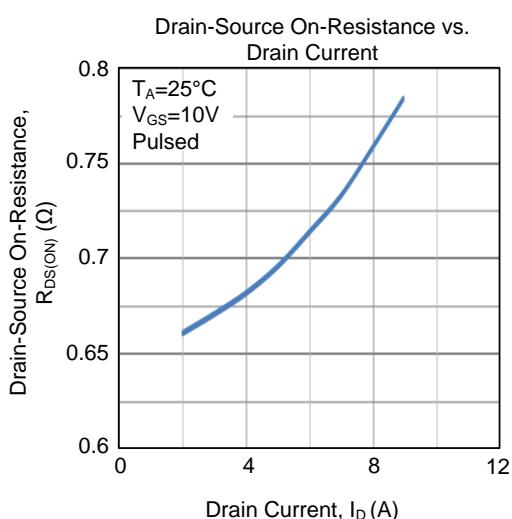
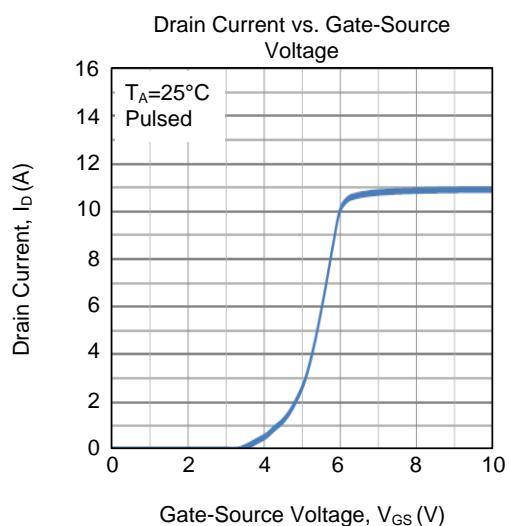
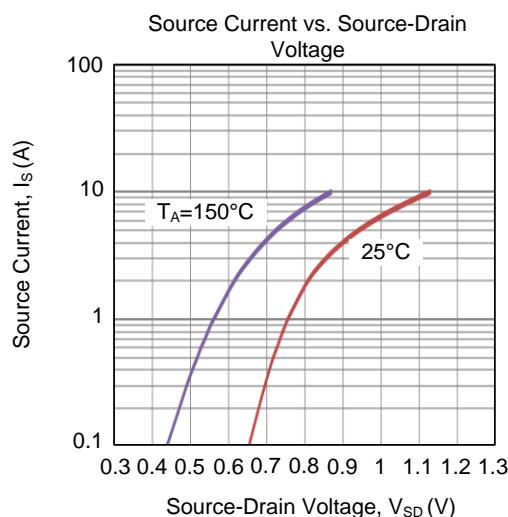
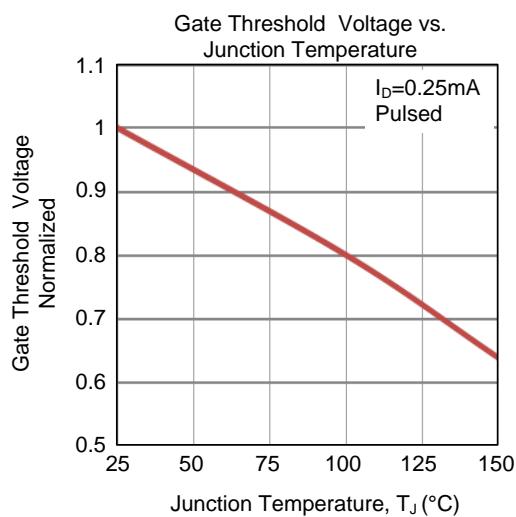


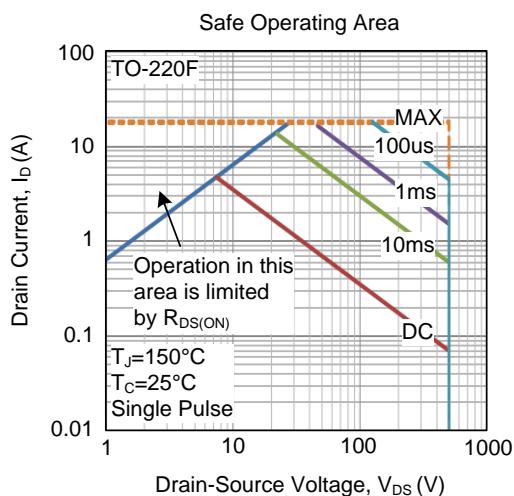
Unclamped Inductive Switching Waveforms

## ■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



**■ TYPICAL CHARACTERISTICS (Cont.)**

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